

This is to certify that the Quality Management System of:

## **Retronix Limited**

North Caldeen Road, Coatbridge, Lanarkshire, ML5 4EF, United Kingdom

(Central function listed above. See appendix for additional locations)

applicable to:

Repair and rework of PCBs and electronic components. Manual and automated alloy conversion of ICs, BGA laser and reflow re-balling. The in house testing of electronic components including electrical test, XRF analysis, ionic contamination, solderability, temperature testing and up-screening

has been assessed and registered by NQA against the provisions of:

## AS9100D & BS EN ISO 9001:2015

in accordance with the requirements of EN 9104-001:2013. This registration is subject to the company maintaining a quality management system, to the above standard, which will be monitored by NQA.

Manya

Managing Director



Certificate No: ISO Approval Date: ASCS Approval Date: Issue Date: Reissue Date: Expiry Date: EAC Code: Site Structure: 72781

10 June 1998 23 February 2018 23 February 2021 8 December 2021 22 February 2024 19, 35, 21 Multiple Sites

The use of the UKAS Accreditation Mark indicates accreditation in respect of those activities covered by the accreditation certificate number 015 held by NQA. NQA is a trading name of NQA Certification Limited, Registration No. 09351758. Registered Office: Warwick House, Houghton Hall Park, Houghton Regis, Dunstable Bedfordshire LU5 5ZX, United Kingdom. This certificate is the property of NQA and must be returned on request.



Appendix to Certificate Number: 72781

**Includes Facilities Located at:** 

## **Retronix Limited**

Certificate Number 72781 North Caldeen Road Coatbridge Lanarkshire ML5 4EF United Kingdom

## **Retronix Ltd**

Certificate Number 72781 1007 S Heatherwilde Blvd Bldg A Pflugerville 78660 United States of America Repair and rework of PCBs and electronic components. Manual and automated alloy conversion of ICs, BGA laser and reflow re-balling. The in house testing of electronic components including electrical test, XRF analysis, ionic contamination, solderability, temperature testing and up-screening

Manual and automated alloy conversion of ICs, BGA reflow re-balling. The in house testing of electronic components including, XRF analysis and solderability

ISO Approval Date: Reissue Date: Expiry Date: 10 June 1998 8 December 2021 22 February 2024